

JP1986-61141116- Abstract Oshima Semiconductor Substrate

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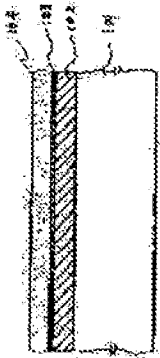
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**(54) SEMICONDUCTOR SUBSTRATE****(57)Abstract:**

PURPOSE: To contrive the improvement in crystallizability of a Ge thin film by alleviating the mismatching of the lattice by changing a composition ratio x of the $\text{Si}_{1-x}\text{Ge}_x$, which is arranged between an Si substrate and a Ge thin film as a buffer layer, from $x=0$ to $x=1$ continuously and monotonously from the Si substrate side toward the Ge thin film.

CONSTITUTION: On an Si substrate 101, an $\text{Si}_{1-x}\text{Ge}_x$ thin film 102 which is to be a buffer layer is formed and a Ge thin film 103 and a GaAs thin film 104 are formed on that. A composition ratio x of the $\text{Si}_{1-x}\text{Ge}_x$ thin film is $x=0$, i.e., the composition of Si in the position where it contacts with the underlying Si substrate 101, and $x=1$, i.e., the composition of Ge in the position where it contacts with the Ge thin film 103 above. Between them, a value of x changes continuously and monotonously from 0 to 1 and the mismatching between Si and Ge is alleviated. The $\text{Si}_{1-x}\text{Ge}_x$ thin film can be formed by a reduced CVD method using monosilane gas and german gas. As the composition ratio x is controlled by a flow ratio of the gas, it can be changed as it is desired by changing a gas flow ratio continuously and monotonously.

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